![ST life.augmented logo]

STGW40NC60KD

600 V, 40 A short-circuit rugged IGBT

TO-247

Features

- Low on-voltage drop ($V_{CE(sat)}$)
- Low C_{res} / C_{ies} ratio (no cross conduction susceptibility)
- Short-circuit withstand time 10 µs
- IGBT co-packaged with ultra fast free-wheeling diode

Applications

- High frequency inverters
- Motor drivers

Description

This IGBT utilizes the advanced PowerMESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.
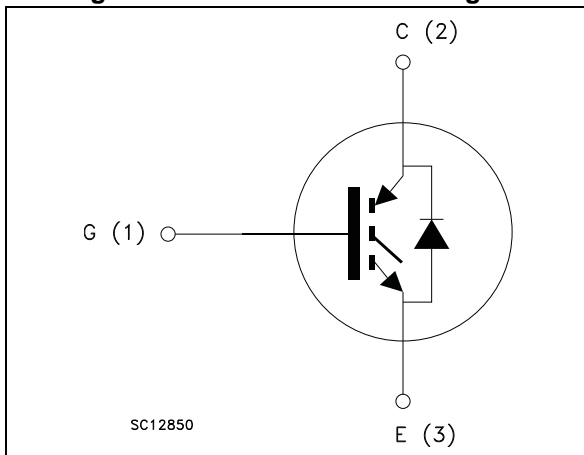
Figure 1. Internal schematic diagram

SC12850

Table 1. Device summary

Order code	Marking	Package	Packaging
STGW40NC60KD	GW40NC60KD	TO-247	Tube

Contents

1   Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-emitter voltage ($V_{GE} = 0$)	600	V
$I_C^{(1)}$	Collector current (continuous) at T_C = 25 °C	70	A
$I_C^{(1)}$	Collector current (continuous) at T_C = 100 °C	38	A
$I_{CL}^{(2)}$	Turn-off latching current	220	A
$I_{CP}^{(3)}$	Pulsed collector current	220	A
V_{GE}	Gate-emitter voltage	±20	V
I_F	Diode RMS forward current at T_C = 25 °C	30	A
I_{FSM}	Surge non repetitive forward current t_p = 10 ms sinusoidal	120	A
P_{TOT}	Total dissipation at T_C = 25 °C	250	W
t_{scw}	Short circuit withstand time, $V_{CE} = 0.5\ V_{(BR)CES}$ T_j = 125°C, R_G = 10 Ω, V_{GE} = 12 V	10	µs
T_j	Operating junction temperature	– 55 to 150	°C

1. Calculated according to the iterative formula:

$$I_C(T_c) = \frac{T_{J(MAX)} - T_c}{R_{thj-c} \times V_{CE(sat)(MAX)} \cdot (T_c, I_c)}$$

2. V_{clamp} = 80%,(V_{CES}), T_j =150°C, R_G = 10 Ω, V_{GE} = 15 V
3. Pulse width limited by max. junction temperature allowed

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case IGBT max.	0.5	°C/W
	Thermal resistance junction-case diode max.	1.5	°C/W
$R_{thj-amb}$	Thermal resistance junction-ambient max	50	°C/W

2 Electrical characteristics

T_{CASE}=25°C unless otherwise specified.

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage (V_{GE}= 0)	I_C = 1 mA	600			V
$V_{CE(sat)}$	Collector-emitter saturation voltage	V_{GE} = 15 V, I_C = 30 A V_{GE} = 15 V, I_C = 30 A, T_C = 125 °C		2.1 1.9	2.7	V V
I_{CES}	Collector cut-off current (V_{GE} = 0)	V_{CE} = 600 V V_{CE} = 600 V, T_C = 125 °C			500 5	µA mA
$V_{GE(th)}$	Gate threshold voltage	V_{CE} = V_{GE}, I_C = 250 µA	4.5		6.5	V
I_{GES}	Gate-emitter cut-off current (V_{CE} = 0)	V_{GE} = ±20 V			±100	nA
g_{fs} [1]	Forward transconductance	V_{CE} = 15 V , I_C = 30 A		20		S

1. Pulsed: Pulse duration = 300 µs, duty cycle 1.5%

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{ies} C_{oes} C_{res}	Input capacitance Output capacitance Reverse transfer capacitance	V_{CE} = 25 V, f = 1 MHz, V_{GE}= 0	-	2870 295 69	-	pF pF pF
Q_g Q_{ge} Q_{gc}	Total gate charge Gate-emitter charge Gate-collector charge	V_{CE} = 480 V, I_C = 30 A, V_{GE} = 15 V *(see Figure 18)*	-	135 27 69.5	-	nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$ t_r $(di/dt)_{on}$	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 480 V, I_C = 30 A R_G=10 Ω, V_{GE}= 15 V, *(see Figure 17)*	-	46 18.5 1530	-	ns ns A/µs
$t_{d(on)}$ t_r $(di/dt)_{on}$	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 480 V, I_C = 30 A R_G=10 Ω, V_{GE}= 15 V, T_C= 125 °C *(see Figure 17)*	-	45 19 1400	-	ns ns A/µs
$t_{r(Voff)}$ $t_{d(off)}$ t_f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 480 V, I_C = 30 A R_G=10 Ω, V_{GE}= 15 V, *(see Figure 17)*	-	38 164 87	-	ns ns ns
$t_{r(Voff)}$ $t_{d(off)}$ t_f	Off voltage rise time Turn-off delay time Current fall time	V_{cc} = 480 V, I_C = 30 A, R_G = 10 Ω, V_{GE} = 15 V T_C= 125 °C *(see Figure 17)*	-	70 208 130	-	ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
E_{on} E_{off} [1] E_{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 480 V, I_C = 30 A R_G= 10 Ω, V_{GE}= 15 V, *(see Figure 17)*	-	595 716 1311	-	µJ µJ µJ
E_{on} E_{off} [1] E_{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 480 V, I_C = 30 A R_G= 10 Ω, V_{GE}= 15 V, T_C= 125 °C *(see Figure 17)*	-	808 1200 2008	-	µJ µJ µJ

1. Turn-off losses include also the tail of the collector current.

Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_F	Forward on-voltage	I_F = 30 A I_F = 30 A, T_C = 125 °C	-	2.4 1.8	-	V V
t_{rr} Q_{rr} I_{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_F = 30 A, V_R = 50 V, di/dt = 100 A/µs *(see Figure 20)*	-	45 56 2.55	-	ns nC A
t_{rr} Q_{rr} I_{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_F = 30 A, V_R = 50 V, T_C =125 °C, di/dt = 100 A/µs *(see Figure 20)*	-	100 290 5.8	-	ns nC A

2.1 Electrical characteristics (curves)

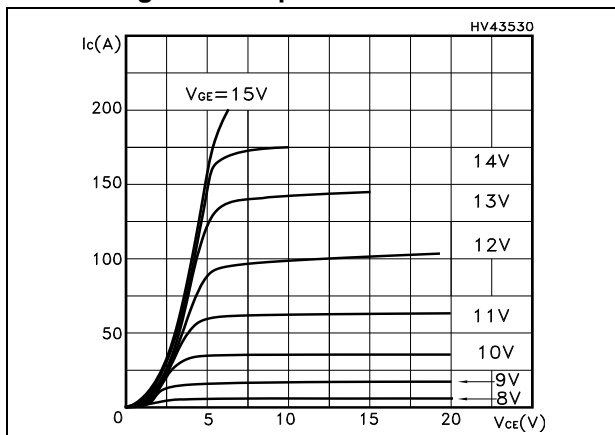**Figure 2. Output characteristics**
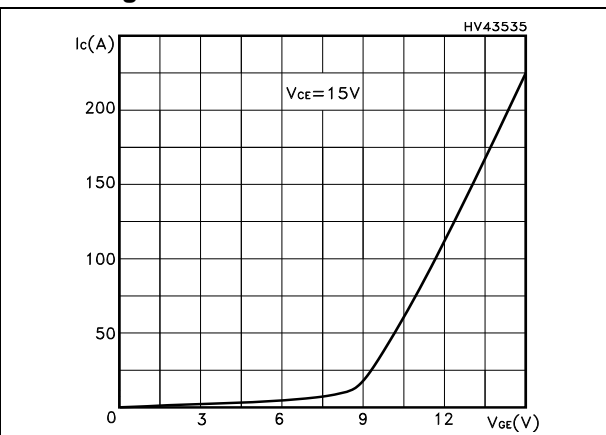

Figure 3. Transfer characteristics
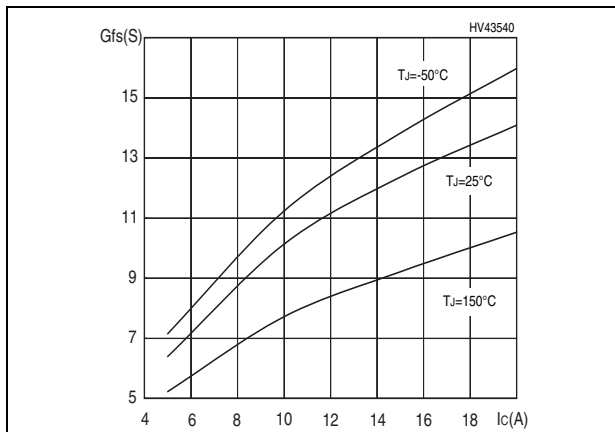

Figure 4. Transconductance

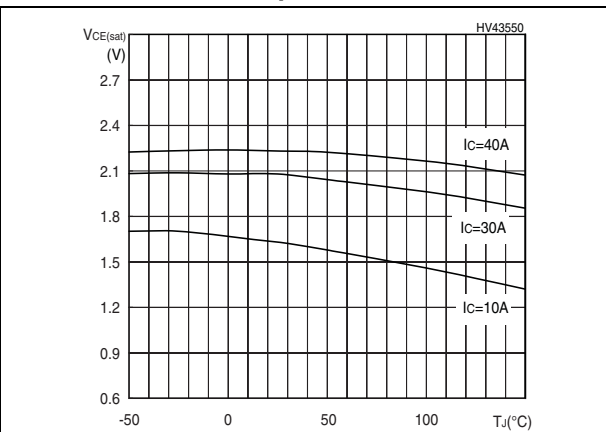**Figure 5. Collector-emitter on voltage vs. temperature**

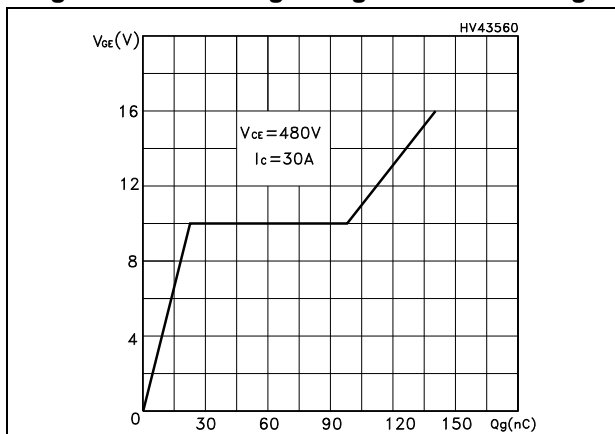**Figure 6. Gate charge vs. gate-source voltage**
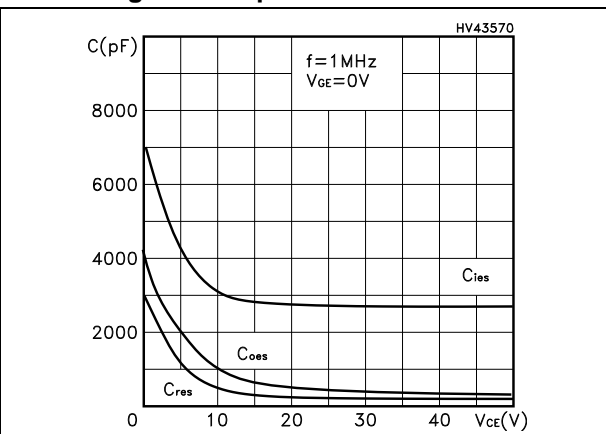

Figure 7. Capacitance variations

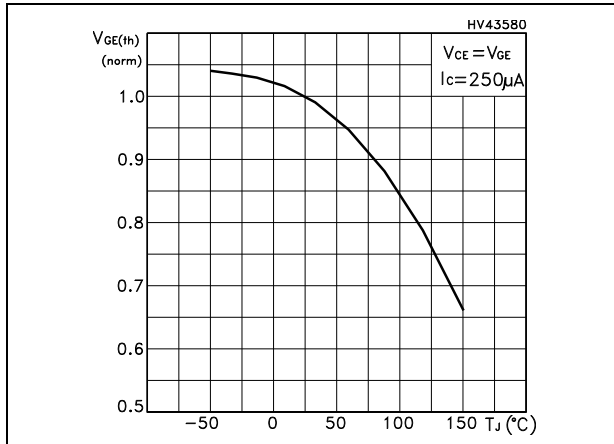**Figure 8. Normalized gate threshold voltage vs. temperature**

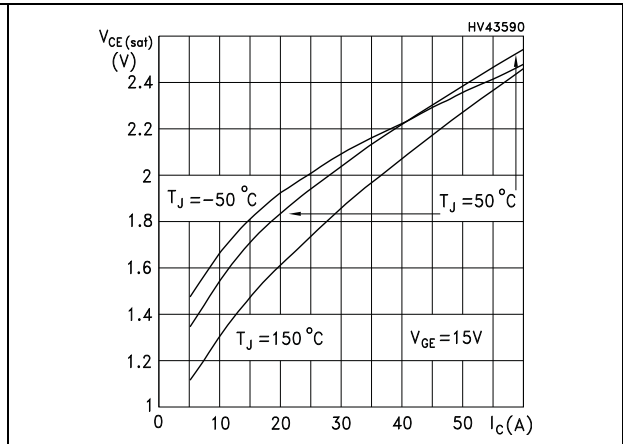**Figure 9. Collector-emitter on voltage vs. collector current**

Figure 10. Normalized breakdown voltage vs. temperature

Figure 11. Switching losses vs. temperature

Figure 12. Switching losses vs. gate resistance

Figure 13. Switching losses vs. collector current

Figure 14. Thermal Impedance

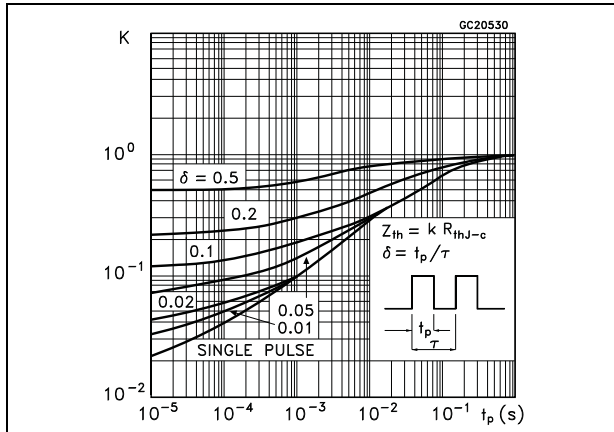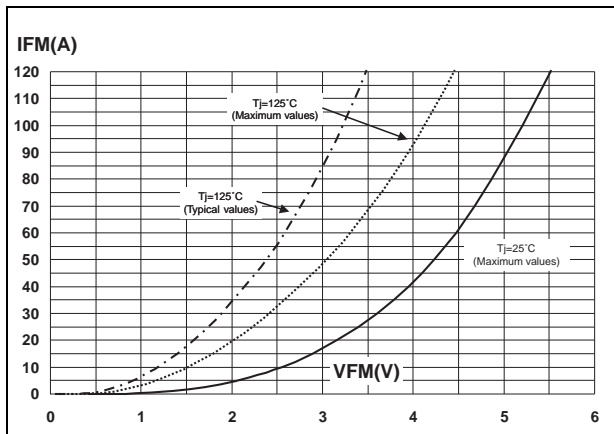**Figure 15. Turn-off SOA**

Figure 16. Forward voltage drop vs. forward current

3   Test circuits
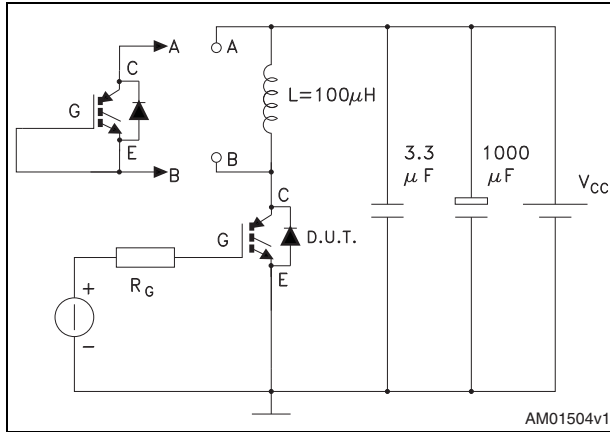
Figure 17. Test circuit for inductive load switching
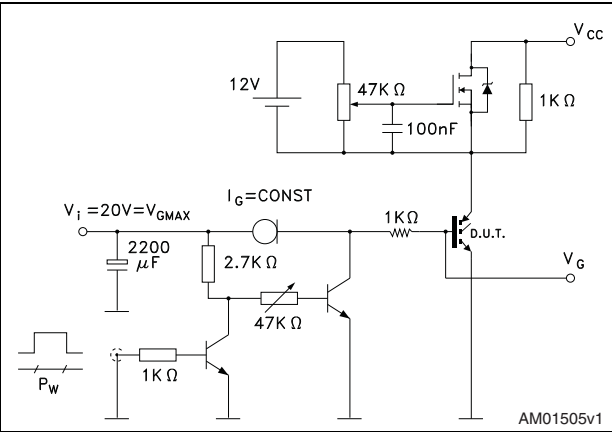

Figure 18. Gate charge test circuit
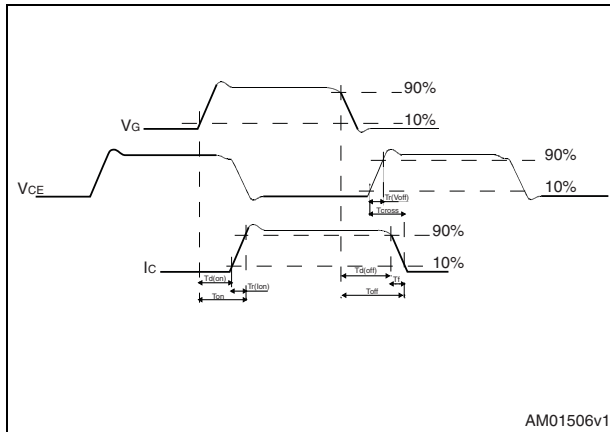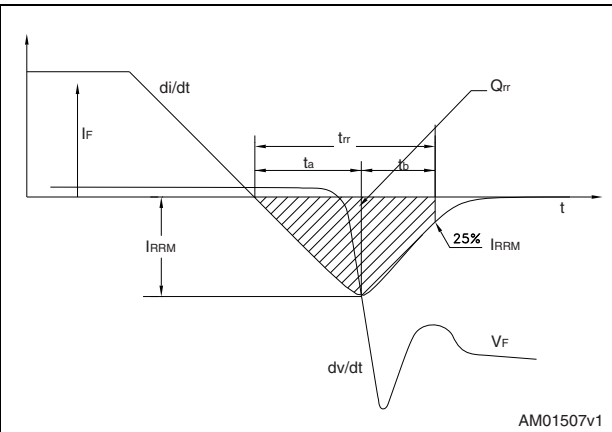

Figure 19. Switching waveform

Figure 20. Diode recovery time waveform

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of
ECOPACK® packages, depending on their level of environmental compliance. ECOPACK®
specifications, grade definitions and product status are available at: *www.st.com*.
ECOPACK® is an ST trademark.
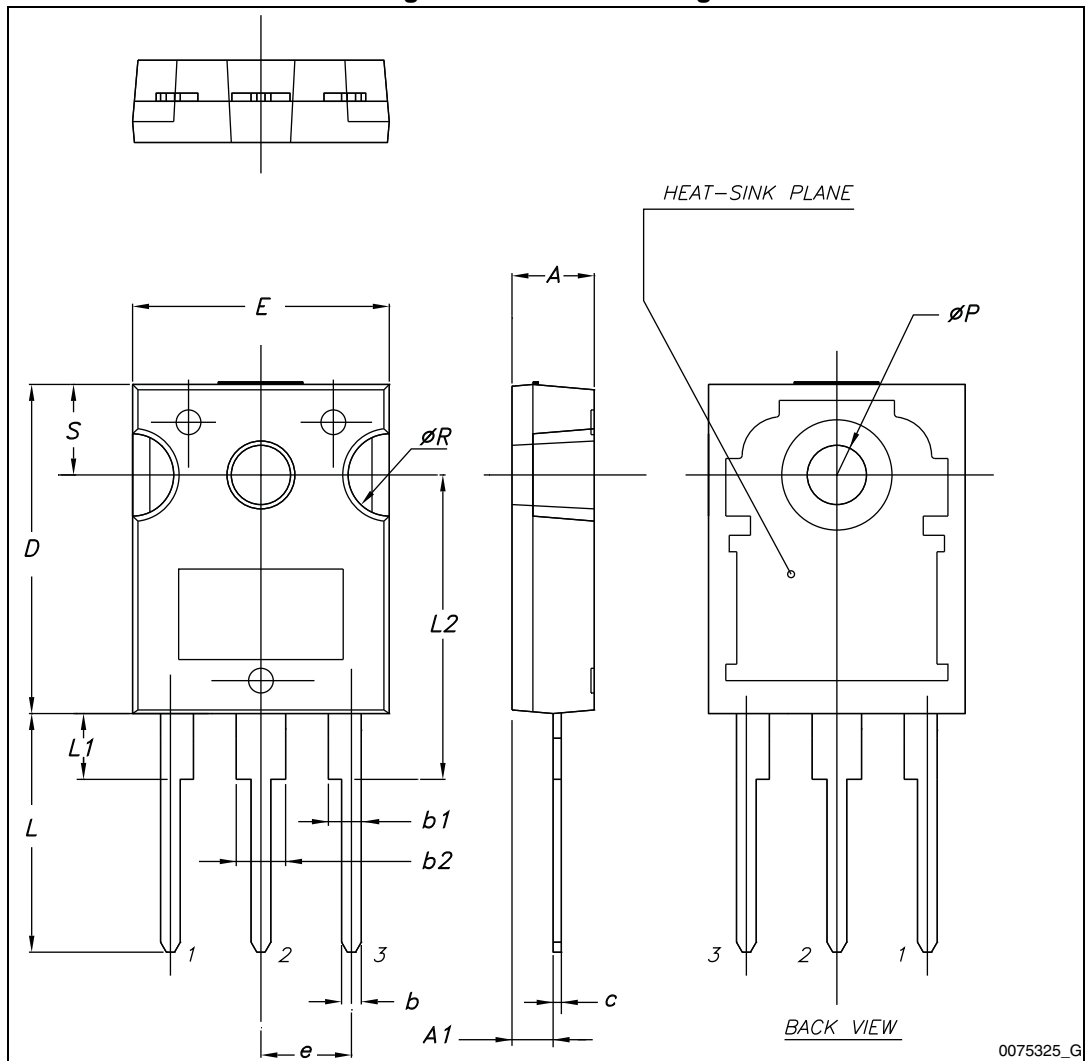
Figure 21. TO-247 drawing

Table 9. TO-247 mechanical data

Dim.	mm.		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
∅P	3.55		3.65
∅R	4.50		5.50
S	5.30	5.50	5.70

5   Revision history

Table 10. Document revision history

Date	Revision	Changes
11-Jun-2008	1	Initial release
12-Mar-2014	2	Modified total switching losses typical value in *Table 7: Switching energy (inductive load)*. Minor text changes.